

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
3818	Chemical elements doped for use in electronics, in form of discs, wafers or similar forms; chemical compounds doped for use in electronics.							
381800	-Chemical elements doped for use in electronics, in form of discs, wafers or similar forms; chemical compounds doped for use in electronics	90	0	2000	WT/Let			0
7017	Laboratory, hygienic or pharmaceutical glassware, whether or not graduated or calibrated							
701710	- Of fused quartz or other fused silica							
ex701710	- Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of Semi-conductor wafers.	83.4	0	2000				0
8419	Machinery, plant or laboratory equipment, whether or not electrically heated, for the treatment of materials by a process involving a change of temperature such as heating, cooking, roasting, distilling, rectifying, sterilising, pasteurising, steaming, drying, evaporating, vaporising, condensing or cooling, other than machinery or plant of a kind used for domestic purposes; instantaneous or storage water heaters, non-electric. Instantaneous or storage water heaters, non-electric:							
841989	- Others							
ex841989	Chemical vapor deposition apparatus for semi-conductor production.	50	0	2000			EC	0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
841990	- Parts							
ex841990	- Parts of Chemical Vapor deposition apparatus for Semiconductor production.	35	0	2000			EC	0
8421	Centrifuges, including centrifugal dryers; filtering or purifying machinery and apparatus, for liquids or gases. -Centrifuges, including centrifugal dryers:							
842119	--Other							
ex842119	---Spin dryers for semiconductor wafer processing -Parts:	45	0	2000	WT/Let		EC/SE	0
842191	--Of centrifuges, including centrifugal dryers							
ex842191	---Parts of spin dryers for semiconductor wafer processing	50	0	2000	WT/Let		EC/SE	0
8424	Mechanical appliances (whether or not hand-operated) for projecting, dispersing or spraying liquids or powders; fire extinguishers, whether or not charged; spray guns and similar appliances; steam or sand blasting machines and similar jet projecting machines. -Other appliances:							
842489	--Other							
ex842489	---Deflash machines for cleaning and removing contaminants from the metal leads of semiconductor packages prior to the electroplating process	61.7	0	2000	WT/Let			0
ex842489	---Spraying appliances for etching, stripping or cleaning semiconductor wafers	61.7	0	2000	WT/Let			0
842490	-Parts							

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
ex842490	--Parts of spraying appliances for etching, stripping or cleaning semiconductor wafers	61.7	0	2000	WT/Let			0
8456	Machine-tools for working any material by removal of material, by laser or other light or photon beam, ultrasonic, electro-discharge, electro-chemical, electron beam, ionic-beam or plasma arc processes.							
845610	-Operated by laser or other light or photon beam processes							
ex845610	--Machines for working any material by removal of material, by laser or other light or photo beam in the production of semiconductor wafers	66.7	0	2000	WT/Let			0
	-Other:							
845691	--For dry-etching patterns on semiconductor materials	66.7	0	2000	WT/Let			0
845699	--Other							
ex845699	---Focused ion beam milling machines to produce or repair masks and reticles for patterns on semiconductor devices	66.7	0	2000	WT/Let			0
ex845699	Laser cutters for cutting contacting tracks in semi-conductor production by laser beam.	66.7	0	2000				0
8464	Machine-tools for working stone, ceramics, concrete, asbestos-cement or like mineral materials or for cold working glass.							
846410	- Sawing Machines							
ex846410	Machines for sawing monocrystal semiconductor boules into slices, or wafers into chips.	66.7	0	2000				0
846420	-Grinding or polishing machines							
ex846420	--Grinding, polishing and lapping machines for processing of semiconductor wafers	66.7	0	2000	WT/Let			0
846490	-Other							

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
ex846490	--Dicing machines for scribing or scoring semiconductor wafers	66.7	0	2000	WT/Let			0
8466	Parts and accessories suitable for use solely or principally with the machines of headings Nos. 84.56 to 84.65, including work or tool holders, self-opening dieheads, dividing heads and other special attachments for machine-tools; tool holders for any type of tool for working in the hand. -Other:							
846691	--For machines of heading No. 84.64							
ex846691	---Parts of grinding, polishing and lapping machines for processing of semiconductor wafers	66.7	0	2000	WT/Let			0
ex846691	Parts for machines for sawing monocrystal semiconductor boules into slices, or wafers into chips.	66.7	0	2000				0
ex846691	Parts of dicing machines for scribing or scoring semiconductor wafers.	66.7	0	2000				0
846693	--For machines of headings Nos. 84.56 to 84.61							
ex846693	---Parts of focused ion beam milling machines to produce or repair masks and reticles for patterns on semiconductor devices	31.7	0	2000	WT/Let		US	0
ex846693	---Parts of machines for working any material by removal of material, by laser or other light or photo beam in the production of semiconductor wafers	31.7	0	2000	WT/Let		US	0
ex846693	---Parts of machines for dry-etching patterns on semiconductor materials	31.7	0	2000	WT/Let		US	0
ex846693	Parts of laser cutters for cutting contacting tracks in semiconductor production by laser beam.	31.7	0	2000			US	0
ex846693	Parts of apparatus for stripping or cleaning semiconductor wafers.	31.7	0	2000			US	0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
8469	Typewriters other than printers of heading No. 84.71; word-processing machines. -Automatic typewriters and word-processing machines:							
846911	--Word-processing machines	52	0	2005	WT/Let			0
8470	Calculating machines and pocket-size data recording, reproducing and displaying machines with calculating functions; accounting machines, postage-franking machines, ticket-issuing machines and similar machines, incorporating a calculating device; cash registers.							
847010	-Electronic calculators capable of operation without an external source of electric power and pocket-size data recording, reproducing and displaying machines with calculating functions -Other electronic calculating machines:	116.7	0	2005	WT/Let			0
847021	--Incorporating a printing device	52	0	2005	WT/Let			0
847029	--Other	52	0	2005	WT/Let			0
847030	-Other calculating machines	52	0	2005	WT/Let			0
847040	-Accounting machines	52	0	2005	WT/Let			0
847050	-Cash registers	52	0	2005	WT/Let			0
847090	-Other	52	0	2005	WT/Let			0
8471	Automatic data processing machines and units thereof; magnetic or optical readers, machines for transcribing data onto data media in coded form and machines for processing such data, not elsewhere specified or included.							
847110	-Analogue or hybrid automatic data processing machines	66.7	0	2005	WT/Let			0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
847130	-Portable digital automatic data processing machines, weighing no more than 10 kg, consisting of at least a central processing unit, a keyboard and a display -Other digital automatic data processing machines:	66.7	0	2005	WT/Let		US/EC/Japan	0
847141	--Comprising in the same housing at least a central processing unit and an input and output unit, whether or not combined	66.7	0	2005	WT/Let			0
847149	--Other, presented in the form of systems	66.7	0	2005	WT/Let			0
847150	-Digital processing units other than those of subheadings 8471.41 and 8471.49, whether or not containing in the same housing one or two of the following types of unit: storage units, input units, output units	66.7	0	2005	WT/Let			0
847160	-Input or output units, whether or not containing storage units in the same housing	66.7	0	2005	WT/Let			0
ex847170	-Storage units - Floppy disc drives, hard disc drives, CD-Rom drives	66.7	0	2000	WT/Let		US/EC/CA/Japan	0
ex847170	Storage units - other	66.7	0	2005			US/EC/CA/Japan	0
847180	-Other units of automatic data processing machines	66.7	0	2005	WT/Let		US/EC	0
847190	-Other	66.7	0	2005	WT/Let		US/EC	0
8472	Other office machines (for example, hectograph or stencil duplicating machines, addressing machines, automatic banknote dispensers, coin-sorting machines, coin-counting or wrapping machines, pencil-sharpening machines, perforating or stapling machines).							
847290	-Other							
ex847290	--Automatic teller machines	52	0	2005	WT/Let			0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present</u> <u>concession</u> <u>established</u>	<u>INR</u>	<u>Concession first</u> <u>incorporated in</u> <u>a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
8473	Parts and accessories (other than covers, carrying cases and the like) suitable for use solely or principally with machines of headings Nos. 84.69 to 84.72.								
847310	Parts and accessories of the machines of heading no.84.69								
ex847310	Printed circuit assemblies of word processing machines.	52	0	2005	WT/Let				0
	-Parts and accessories of the machines of heading No. 84.70:								
847321	--Of the electronic calculating machines of subheading No. 8470.10, 8470.21 or 8470.29	110	0	2004	WT/Let				0
847329	--Other	110	0	2004	WT/Let				0
847330	-Parts and accessories of the machines of heading No. 8471:								
ex847330	- Populated PCBs	66.7	0	2005	WT/Let		US/EC/CA		0
ex847330	- Other	66.7	0	2005	WT/Let		Japan		0
847340	Parts and accessories of the machines of heading no. 84.72								
ex847340	Printed circuit assemblies for automatic teller machines	110	0	2005	WT/Let				0
847350	-Parts and accessories equally suitable for use with machines of two or more of the headings Nos. 84.69 to 84.72	66.7	0	2005	WT/Let		US/EC/CA/Japan		
8477	Machinery for working rubber or plastics or for the manufacture of products from these materials, nor specified or included elsewhere in this Chapter.								
847710	- Injection - moulding machines.								
ex847710	Encapsulation equipment for assembly of semiconductors	61.7	0	2000					0
847790	- Parts								
ex847790	Parts of encapsulation equipment	61.7	0	2000					0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
8479	Machines and mechanical appliances having individual functions, not specified or included elsewhere in this Chapter. -Other machines and mechanical appliances:							
847950	- Industrial robots, not elsewhere specified or included							
ex847950	Automated machines for transport, handling and storage of semiconductor wafers, cassettes, wafer boxes and other material for semiconductor devices	66.7	0	2000				0
847989	--Other							
ex847989	---Apparatus for growing or pulling monocrystal semiconductor boules	90	0	2000	WT/Let			0
ex847989	---Epitaxial deposition machines for semiconductor wafers	90	0	2000	WT/Let			0
ex847989	Apparatus for physical deposition by sputtering on semiconductor wafers.	90	0	2000				0
ex847989	Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays.	90	0	2000				0
ex847989	Die attach apparatus, tape automated bonders and wire bonders for assembly of semiconductors	90	0	2000				0
ex847989	Encapsulation equipment for assembly of semiconductors	90	0	2000				0
ex847989	Machines for bending, folding and straightening semiconductor leads.	90	0	2000				0
ex847989	Physical deposition apparatus for semiconductor production	90	0	2000				0
ex847989	Spinners for coating photographic emulsions on semiconductor wafers.	90	0	2000				0
847990	-Parts							

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
ex847990	--Parts of apparatus for growing or pulling monocrystal semiconductor boules	61.7	0	2000	WT/Let			0
ex847990	--Parts of epitaxial deposition machines for semiconductor wafers	61.7	0	2000	WT/Let			0
ex847990	Parts of apparatus for physical deposition by sputtering on semiconductor wafers.	61.7	0	2000				0
ex847990	Parts for die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors.	61.7	0	2000				0
ex847990	Parts for spinners for coating photographic emulsions on semiconductor wafers.	61.7	0	2000				0
ex847990	Parts of apparatus for wet etching, developing stripping or cleaning semiconductor wafers and flat panel displays.	61.7	0	2000				0
ex847990	Parts of automated machines for transport handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	61.7	0	2000				0
ex847990	Parts of encapsulation equipment for assembly of semiconductors.	61.7	0	2000				0
ex847990	Parts of machines for bending, folding and straightening semiconductor leads.	61.7	0	2000				0
ex847990	Parts of physical deposition apparatus for semiconductor production	61.7	0	2000				0
8480	Moulding boxes for metal foundry; mould bases; moulding patterns; moulds for metal (other than ingot moulds), metal carbides, glass, mineral materials, rubber or plastics.							
	-Moulds for rubber or plastics:							
848071	--Injection or compression types							

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
ex848071	---Injection and compression moulds for the manufacture of semiconductor devices	55	0	2000	WT/Let			0
8504	Electrical transformers, static converters (for example, rectifiers) and inductors.							
850440	-Static converters							
ex850440	--Static converters for automatic data processing machines and units thereof, and telecommunication apparatus	61.7	0	2005	WT/Let			0
850450	-Other inductors							
ex850450	--Other inductors for power supplies for automatic data processing machines and units thereof, and telecommunication apparatus	116.7	0	2005	WT/Let			0
850490	Parts							
ex850490	Printed circuit assemblies for static converters for automatic data processing machines and units thereof, and telecommunication apparatus; printed circuit assemblies for other inductors for power supplies for automatic data processing machines and units thereof, and telecommunication apparatus	61.7	0	2005	WT/Let			0
8514	Industrial or laboratory electric (including induction or dielectric) furnaces and ovens; other industrial or laboratory induction or dielectric heating equipment.							
851410	-Resistance heated furnaces and ovens							
ex851410	--Resistance heated furnaces and ovens for the manufacture of semiconductor devices on semiconductor wafers	35	0	2000	WT/Let		EC	0
851420	-Induction or dielectric furnaces and ovens							

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
ex851420	--Inductance or dielectric furnaces and ovens for the manufacture of semiconductor devices on semiconductor wafers	35	0	2000	WT/Let		US/EC/AU/Japan	0
851430	-Other furnaces and ovens							
ex851430	--Parts of resistance heated furnaces and ovens for the manufacture of semiconductor devices on semiconductor wafers	35	0	2000	WT/Let		EC/US/NOR/Japan	0
ex851430	Apparatus for rapid heating of semiconductor wafers.	35	0	2000			EC/US/NOR/Japan	0
851490	-Parts							
ex851490	--Parts of furnaces and ovens of Headings No 8514 10 to No 8514 30	31.7	0	2000	WT/Let		NOR	0
ex851490	Parts of apparatus for rapid heating of wafers	31.7	0	2000				0
8517	Electrical apparatus for line telephony or line telegraphy, including line telephone sets with cordless handsets and telecommunication apparatus for carrier-current line systems or for digital line systems; videophones.							
	-Telephone sets; videophones:							
851711	--Line telephone sets with cordless handsets	42	0	2005	WT/Let			0
851719	--Other	42	0	2005	WT/Let			0
	-Facsimile machines and teleprinters:							
851721	--Facsimile machines	42	0	2005	WT/Let			0
851722	--Teleprinters	42	0	2005	WT/Let			0
851730	-Telephonic or telegraphic switching apparatus	42	0	2005	WT/Let			0
851750	-Other apparatus, for carrier-current line systems or for digital line systems	42	0	2005	WT/Let			0
851780	Other apparatus							

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
ex851780	-Set top boxes which have a communication function: A microprocessor-based device incorporating a modem for gaining access to the internet and having a function of interactive information exchange.	42	0	2005	WT/Let			0
ex851780	- Other apparatus - Other	42	0	2005				0
851790	-Parts							0
ex851790	- Populated PCBs	32	0	2005	WT/Let			0
ex851790	- Other	32	0	2005	WT/Let			0
8518	Microphones and stands therefor; loudspeakers, whether or not mounted in their enclosures; headphones, earphones and combined microphone/speaker sets; audio-frequency electric amplifiers; electric sound amplifier sets.							
851810	-Microphones and stands therefor							
ex851810	--Microphones having a frequency range of 300 Hz to 3,4 KHz with a diameter of not exceeding 10 mm and a height not exceeding 3 mm, for telecommunication use	22	0	2005	WT/Let			0
	-Loudspeakers, whether or not mounted in their enclosures:							
851829	--Other							
ex851829	---Loudspeakers, without housing, having a frequency range of 300 Hz to 3,4 KHz with a diameter of not exceeding 50mm, for telecommunication use - cone type	22	0	2005				0
ex851829	---Loudspeakers, without housing, having a frequency range of 300 Hz to 3,4 KHz with a diameter of not exceeding 50mm, for telecommunication use - Other than cone type	52	0	2005				0
851830	-Headphones, earphones and combined microphone/speaker sets							

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
ex851830	--Line telephone handsets	52	0	2005	WT/Let			0
851890	Parts							
ex851890	Printed circuit assemblies for microphones having a frequency range of 300 Hz. to 3,4 KHz. with a diameter not exceeding 10 mm. and a height not exceeding 3 mm. for telecommunication use; printed circuit assemblies for loud speakers, without housing, having a frequency range of 300 Hz. to 3,4 KHz. with a diameter not exceeding 50 mm., for telecommunication use; printed circuit assemblies for line telephone handsets	32	0	2005	WT/Let			0
8520	Magnetic tape recorders and other sound recording apparatus, whether or not incorporating a sound reproducing device							
852020	-Telephone answering machines	52	0	2005	WT/Let			0
8522	Parts and accessories suitable for use solely or principally with the apparatus of heading nos. 85.19 to 85.21							
8522.90	Other							
ex8522.90	Printed circuit assemblies for telephone answering machines	52	0	2005	WT/Let			0
8523	Prepared unrecorded media for sound recording or similar recording of other phenomena, other than products of Chapter 37.							
	-Magnetic tapes:							
852311	--Of a width not exceeding 4 mm	52	0	2005	WT/Let			0
852312	--Of a width exceeding 4 mm but not exceeding 6.5 mm	52	0	2005	WT/Let			0
852313	--Of a width exceeding 6.5 mm	52	0	2005	WT/Let			0
852320	Magnetic discs							
ex852320	-Magnetic discs (other than floppy disc/CD Rom)	52	0	2005	WT/Let			0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
ex852320	- Floppy disc	22	0	2005	WT/Let			0
ex852320	- CD Rom	12	0	2000	WT/Let			0
852390	-Other	52	0	2005	WT/Let			0
8524	Records, tapes and other recorded media for sound or other similarly recorded phenomena, including matrices and masters for the production of records, but excluding products of Chapter 37.							
	-Discs for laser reading systems:							
852431	--For reproducing phenomena other than sound or image							
ex852431	--- For reproducing phenomena other than sound or image recorded in a machine readable binary form, and capable of being manipulated or providing inter activity to a user, by means of an automatic data processing machine	12	0	2000	WT/Let			0
ex852431	---Other	52	0	2005	WT/Let			0
852439	--Other							
ex852439	---For reproducing representations of instructions, data, sound, and image, recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to a user, by means of an automatic data processing machine	12	0	2000	WT/Let			0
852440	-Magnetic tapes for reproducing phenomena other than sound or image							
ex852440	-- For reproducing phenomena other than sound or image recorded in a machine readable binary form, and capable of being manipulated or providing inter activity to a user, by means of an automatic data processing machine	12	0	2000	WT/Let			0
ex852440	--Other	52	0	2005	WT/Let			0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
852491	--For reproducing phenomena other than sound or image							
ex852491	--- For reproducing phenomena other than sound or image recorded in a machine readable binary form, and capable of being manipulated or providing inter activity to a user, by means of an automatic data processing machine	12	0	2000	WT/Let			0
ex852491	---Other	52	0	2005	WT/Let			0
852499	--Other							
ex852499	---For reproducing representations of instructions, data, sound, and image, recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to a user, by means of an automatic data processing machine	12	0	2000	WT/Let			0
8525	Transmission apparatus for radio-telephony, radio-telegraphy, radio-broadcasting or television, whether or not incorporating reception apparatus or sound recording or reproducing apparatus; television cameras; still image video cameras and other video camera recorders.							
852510	-Transmission apparatus							
ex852510	--Transmission apparatus other than apparatus for radio-broadcasting or television	42	0	2005	WT/Let			0
852520	-Transmission apparatus incorporating reception apparatus	42	0	2005	WT/Let			0
852540	-Still image video cameras and other video camera recorders							
ex852540	--Digital still image video cameras	52	0	2005	WT/Let			0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
8527	Reception apparatus for radio-telephony, radio-telegraphy or radio-broadcasting, whether or not combined, in the same housing, with sound recording or reproducing apparatus or a clock.							
852790	-Other apparatus							
ex852790	--Portable receivers for calling, alerting or paging	110	0	2005	WT/Let			0
8529	Parts suitable for use solely or principally with the apparatus of headings Nos. 85.25 to 85.28.							
852910	-Aerials and aerial reflectors of all kinds; parts suitable for use therewith							
ex852910	--Aerials or antennae of a kind used with apparatus for radio-telephony and radio-telegraphy	32	0	2005	WT/Let			0
852990	-Other							
ex852990	--Populated PCBs for : transmission apparatus other than apparatus for radio-broadcasting or television transmission apparatus incorporating reception apparatus digital still image video cameras, portable receivers for calling, alerting or paging	32	0	2005	WT/Let			0
ex852990	--Parts (other than populated PCBs) of: transmission apparatus other than apparatus for radio-broadcasting or television transmission apparatus incorporating reception apparatus digital still image video cameras, portable receivers for calling, alerting or paging	32	0	2005	WT/Let			0
8531	Electric sound or visual signalling apparatus (for example, bells, sirens, indicator panels, burglar or fire alarms), other than those of heading No. 85.12 or 85.30.							

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
ex853120	- Indicator panels incorporating Liquid Crystal Devices (LCD)	52	0	2003	WT/Let			0
ex853120	- Indicator panels incorporating Light Emitting Diodes (LED)	52	0	2005	WT/Let			0
853180	-Other apparatus							
ex853180	--Flat panel display devices of a kind used in automatic data processing machines and telecommunications apparatus	52	0	2005	WT/Let			0
853190	-Parts							
ex853190	--Parts of indicator panels incorporating LCD	52	0	2003	WT/Let			0
ex853190	--Parts of indicator panels incorporating LED	52	0	2005	WT/Let			0
8532	Electrical capacitors, fixed, variable or adjustable (pre-set).							
853210	-Fixed capacitors designed for use in 50/60 Hz circuits and having a reactive power handling capacity of not less than 0.5 kvar (power capacitors)	76.7	0	2005	WT/Let			0
	-Other fixed capacitors:							
853221	--Tantalum	76.7	0	2000	WT/Let			0
853222	--Aluminium electrolytic	76.7	0	2005	WT/Let			0
853223	--Ceramic dielectric, single layer	76.7	0	2005	WT/Let			0
853224	--Ceramic dielectric, multilayer	76.7	0	2000	WT/Let			0
853225	--Dielectric of paper or plastics	76.7	0	2005	WT/Let			0
853229	--Other	76.7	0	2005	WT/Let			0
853230	-Variable or adjustable (pre-set) capacitors	76.7	0	2005	WT/Let			0
853290	-Parts	110	0	2000	WT/Let			0
8533	Electrical resistors (including rheostats and potentiometers), other than heating resistors.							
853310	-Fixed carbon resistors, composition or film types	76.7	0	2005	WT/Let			0
	-Other fixed resistors:							

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
853321	--For a power handling capacity not exceeding 20 W	76.7	0	2005	WT/Let			0
853329	--Other -Wirewound variable resistors, including rheostats and potentiometers:	76.7	0	2005	WT/Let			0
853331	--For a power handling capacity not exceeding 20 W	76.7	0	2005	WT/Let			0
853339	--Other	76.7	0	2005	WT/Let			0
853340	-Other variable resistors, including rheostats and potentiometers	76.7	0	2005	WT/Let			0
853390	-Parts	110	0	2000	WT/Let			0
8534	Printed circuits.							
853400	-Printed circuits	76.7	0	2005	WT/Let			0
8536	Electrical apparatus for switching or protecting electrical circuits, or for making connections to or in electrical circuits (for example, switches, relays, fuses, surge suppressors, plugs, sockets, lamp-holders, junction boxes), for a voltage not exceeding 1,000 volts.							
853650	-Other switches							
ex853650	--Electronic AC switches consisting of optically coupled input and output circuits (Insulated thyristor AC switches)	110	0	2005	WT/Let			0
ex853650	--Electronic switches, including temperature protected electronic switches, consisting of a transistor and a logic chip (chip-on-chip technology) for a voltage not exceeding 1000 volts	110	0	2005	WT/Let			0
ex853650	--Electromechanical snap-action switches for a current not exceeding 11 amps, switches of contact rating less than 5 Amp at voltage not exceeding 250 volts.	110	0	2005	WT/Let			0
853669	--Other							

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
ex853669	---Plugs and sockets for co-axial cables and printed circuits	110	0	2005	WT/Let			0
853690	-Other apparatus							
ex853690	--Connection and contact elements for wires and cables	110	0	2005	WT/Let			0
ex853690	Wafer probers	110	0	2000				0
8538	Parts suitable for use solely or principally with the apparatus of heading nos. 85.35, 85.36 or 85.37							
853890	Other							
ex853890	Printed circuit assemblies for the following goods of heading no.85.36 :- (1) electronic AC switches consisting of optically coupled input and output circuits (insulated thyristor AC switches) (2) electronic switches, including temperature protected electronic switches, consisting of a transistor and a logic chip (chip-on-chip technology) for a voltage not exceeding 1000 volts (3) electro-mechanical snap-action switches for a current not exceeding 11 amperes, switches of contact rating less than 5 amperes at voltage not exceeding 250 volts (4) plugs and sockets for co-axial cables and printed circuits (5) connection and contact elements for wires and cables (6) wafer probers	110	0	2005	WT/Let			0
8541	Diodes, transistors and similar semiconductor devices; photosensitive semiconductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light emitting diodes; mounted piezo-electric crystals.							
854110	-Diodes, other than photosensitive or light emitting diodes	66.7	0	2005	WT/Let			0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
	-Transistors, other than photosensitive transistors:							
854121	--With a dissipation rate of less than 1 W	66.7	0	2005	WT/Let			0
854129	--Other	66.7	0	2005	WT/Let			0
854130	-Thyristors, diacs and triacs, other than photosensitive devices	66.7	0	2005	WT/Let			0
854140	-Photosensitive semiconductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light emitting diodes	66.7	0	2005	WT/Let			0
854150	-Other semiconductor devices	66.7	0	2005	WT/Let			0
854160	-Mounted piezo-electric crystals	66.7	0	2005	WT/Let			0
854190	-Parts	110	0	2000	WT/Let			0
8542	Electronic integrated circuits and microassemblies.							
	-Monolithic digital integrated circuits:							
854212	--Cards incorporating an electronic integrated circuit ("smart" cards)	66.7	0	2005	WT/Let			0
854213	--Metal oxide semiconductors (MOS technology)	66.7	0	2005	WT/Let			0
854214	--Circuits obtained by bipolar technology	66.7	0	2005	WT/Let			0
854219	--Other, including circuits obtained by a combination of bipolar and MOS technologies (BIMOS technology)	66.7	0	2005	WT/Let			0
854230	-Other monolithic integrated circuits	66.7	0	2005	WT/Let			0
854240	-Hybrid integrated circuits	66.7	0	2005	WT/Let			0
854250	-Electronic microassemblies	66.7	0	2005	WT/Let			0
854290	-Parts	110	0	2000	WT/Let			0
8543	Electrical machines and apparatus, having individual functions, not specified or included elsewhere in this Chapter.							
	-Particle accelerators:							

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
854311	--Ion implanters for doping semiconductor materials	116.7	0	2000	WT/Let			0
ex854330	Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays. -Other machines and apparatus:	116.7	0	2000				0
854381	--Proximity cards and tags	116.7	0	2005	WT/Let			0
854389	--Other							
ex854389	---Electrical machines with translation or dictionary functions	116.7	0	2005	WT/Let			0
ex854389	Pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	116.7	0	2000	WT/Let			0
854390	-Parts							
ex854390	--Parts of ion implanters for doping semiconductor materials	116.7	0	2000	WT/Let			0
ex854390	Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays.	116.7	0	2000	WT/Let			0
ex854390	Parts and accessories of pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	116.7	0	2000	WT/Let			0
ex854390	Printed circuit assemblies for proximity cards and tags, printed circuit assemblies for electrical machines with translation or dictionary functions	116.7	0	2005	WT/Let			0
8544	Insulated (including enamelled or anodised) wire, cable (including co-axial cable) and other insulated electric conductors, whether or not fitted with connectors; optical fibre cables, made up of individually sheathed fibres, whether or not assembled with electric conductors or fitted with connectors.							

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
	-Other electric conductors, for a voltage not exceeding 80 V:							
854441	--Fitted with connectors							
ex854441	---Other electric conductors, for a voltage not exceeding 80 V, fitted with connectors, of a kind used for telecommunications	90	0	2005	WT/Let			0
854449	--Other							
ex854449	---Other electric conductors, for a voltage not exceeding 80 V, not fitted with connectors, of a kind used for telecommunications	90	0	2005	WT/Let			0
	-Other electric conductors, for a voltage exceeding 80 V but not exceeding 1,000 V:							
854451	--Fitted with connectors							
ex854451	---Other electric conductors, for a voltage exceeding 80 V but not exceeding 1000 V, fitted with connectors, of a kind used for telecommunications	90	0	2005	WT/Let			0
854470	-Optical fibre cables	110	0	2005	WT/Let			0
9009	Photo-copying apparatus incorporating an optical system or of the contact type and thermo-copying apparatus.							
	-Electrostatic photo-copying apparatus:							
900911	--Operating by reproducing the original image directly onto the copy (direct process)	110	0	2005	WT/Let			0
	-Other photo-copying apparatus:							
900921	--Incorporating an optical system	110	0	2005	WT/Let			0
900990	-Parts and accessories	110	0	2005	WT/Let			0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
9010	Apparatus and equipment for photographic (including cinematographic) laboratories (including apparatus for the projection or drawing of circuit patterns on sensitised semiconductor materials), not specified or included elsewhere in this Chapter; negatoscopes; projection screens. -Apparatus for the projection or drawing of circuit patterns on sensitised semiconductor materials:							
901041	--Direct write-on-wafer apparatus	110	0	2000	WT/Let			0
901042	--Step and repeat aligners	110	0	2000	WT/Let			0
901049	--Other	110	0	2000	WT/Let			0
901090	-Parts and accessories							
ex901090	--Parts and accessories of the apparatus of Headings No 9010 41 to 9010 49	110	0	2000	WT/Let			0
9011	Compound optical microscopes, including those for photomicrography, cinephotomicrography or microprojection.							
901110	- Stereoscopic microscopes.							
ex901110	Optical stereoscopic microscopies fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles.	70	0	2000				0
901120	- Other microscopies, for photomicrography, cinephotomicrography or microprojection.							
ex901120	Photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles.	70	0	2000				0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
901190	- Parts and accessories.							
ex901190	Parts and accessories of optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles.	70	0	2000				0
ex901190	Parts and accessories of photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles.	70	0	2000				0
9012	Microscopes other than optical microscopes; diffraction apparatus.							
901210	- Microscopes other than optical microscopes and diffraction apparatus.							
ex901210	Electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles.	70	0	2000				0
901290	- Parts and accessories.							
ex901290	Parts and accessories of electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles.	70	0	2000				0
9017	Drawing, marking out or mathematical calculating instruments (for example, drafting machines, pantographs, protractors, drawing sets, slide rules, discalculators); instruments for measuring length, for use in the hand (for example, measuring rods and tapes, micrometers, calipers), not specified or included elsewhere in this Chapter.							
ex901710	Drafting machines of heading no. 9017.	40	0	2005				0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
901720	- Other drawing, marking-out or mathematical calculating instruments.							
ex901720	Pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates.	40	0	2000				0
ex901720	Drawing machines of heading no. 9017.	40	0	2005				0
901790	- Parts and accessories.							
ex901790	Parts and accessories for pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates.	110	0	2000				0
ex901790	Printed circuit assemblies for drafting machines of heading no.90.17, printed circuit assemblies for drawing machines of heading no.90.17	110	0	2005	WT/Let			0
9026	Instruments and apparatus for measuring or checking the flow, level, pressure or other variables of liquids or gases (for example, flow meters, level gauges, manometers, heat meters), excluding instruments and apparatus of heading No. 90.14, 90.15, 90.28 or 90.32.							
902610	-For measuring or checking the flow or level of liquids	40	0	2005	WT/Let			0
902620	-For measuring or checking pressure	40	0	2005	WT/Let			0
902680	-Other instruments or apparatus	40	0	2005	WT/Let			0
902690	-Parts and accessories	110	0	2003	WT/Let			0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
9027	Instruments and apparatus for physical or chemical analysis (for example, polarimeters, refractometers, spectrometers, gas or smoke analysis apparatus); instruments and apparatus for measuring or checking viscosity, porosity, expansion, surface tension or the like; instruments and apparatus for measuring or checking quantities of heat, sound or light (including exposure meters); microtomes.							
902720	-Chromatographs and electrophoresis instruments	35	0	2005	WT/Let		EC/Japan/US0	
902730	-Spectrometers, spectrophotometers and spectrographs using optical radiations (UV, visible, IR)	35	0	2005	WT/Let		EC/Japan/US0	
902750	-Other instruments and apparatus using optical radiations (UV, visible, IR)	35	0	2005	WT/Let		EC/Japan/US0	
902780	-Other instruments and apparatus	35	0	2005	WT/Let		EC/Japan/US0	
902790	-Microtomes; parts and accessories							
ex902790	--Parts and accessories of products of heading 9027, other than for gas or smoke analysis apparatus and microtomes	35	0	2003	WT/Let		EC/Japan/US0	
9030	Oscilloscopes, spectrum analysers and other instruments and apparatus for measuring or checking electrical quantities, excluding meters of heading No. 90.28; instruments and apparatus for measuring or detecting alpha, beta, gamma, X-ray, cosmic or other ionising radiations.							

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
903040	-Other instruments and apparatus, specially designed for telecommunications (for example, cross-talk meters, gain measuring instruments, distortion factor meters, psophometers)	70	0	2005	WT/Let			0
903082	-Other instruments and apparatus: --For measuring or checking semiconductor wafers or devices	40	0	2000	WT/Let			0
903090	-Parts and accessories							
ex903090	--Parts and accessories of instruments and apparatus for measuring or checking semiconductor wafers or devices	40	0	2000	WT/Let			0
ex903090	--Parts of instruments and appliances for measuring or checking semiconductor wafers or devices	40	0	2000	WT/Let			0
9031	Measuring or checking instruments, appliances and machines, not specified or included elsewhere in this Chapter; profile projectors. -Other optical instruments and appliances:							
903141	--For inspecting semiconductor wafers or devices or for inspecting photomasks or reticles used in manufacturing semiconductor devices	40	0	2000	WT/Let			0
903149	--Other							
ex903149	---Optical instruments and appliances for measuring surface particulate contamination on semiconductor wafers	40	0	2000	WT/Let			0
903190	-Parts and accessories							

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation*</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INR</u>	<u>ODCs</u>
ex903190	--Parts and accessories of optical instruments and appliances for inspecting semiconductor wafers or devices or for inspecting masks, photomasks or reticles used in manufacturing semiconductor devices	40	0	2000	WT/Let			0
ex903190	--Parts and accessories of optical instruments and appliances for measuring surface particulate contamination on semiconductor wafers	40	0	2000	WT/Let			0
702000	Other articles of glass							
ex702000	Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of semi conductor wafers	110	0	2000	WT/Let			0
9013	Liquid crystal devices not constituting articles provided for more specifically in other headings, lasers, other than laser diodes; other optical appliances and instruments, not specified or included elsewhere in this chapter							
901380	Other devices, appliances and instruments							
ex901380	Liquid crystal devices	22	0	2000	WT/Let			0
901390	Parts and accessories							
ex901390	Parts and accessories of LCD	22	0	2000	WT/Let			0

* The changes in the Tariffs will be made effective from 1 March since normally tariff changes are given effect to from 1 March on the basis of the Budget presented to the Parliament on the last day of February.